

# 2SK1968

Silicon N-Channel MOS FET

**HITACHI**

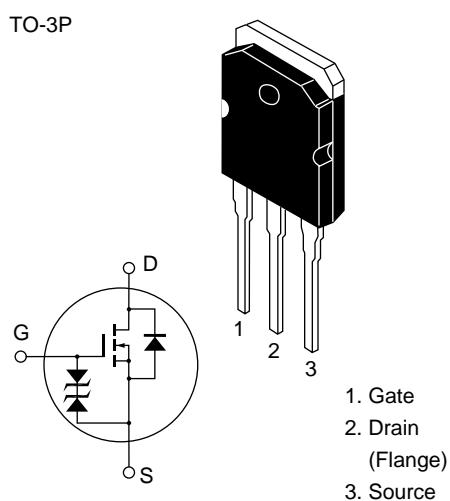
## Application

High speed power switching

## Features

- Low on-resistance
- High speed switching
- No secondary breakdown
- Suitable for Switching regulator
- Low drive current

## Outline



**Absolute Maximum Ratings (Ta = 25°C)**

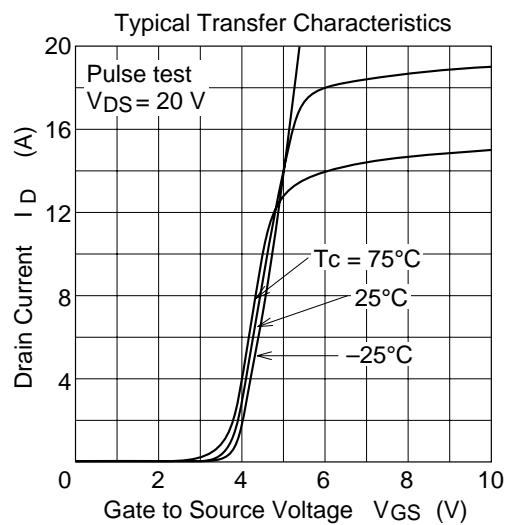
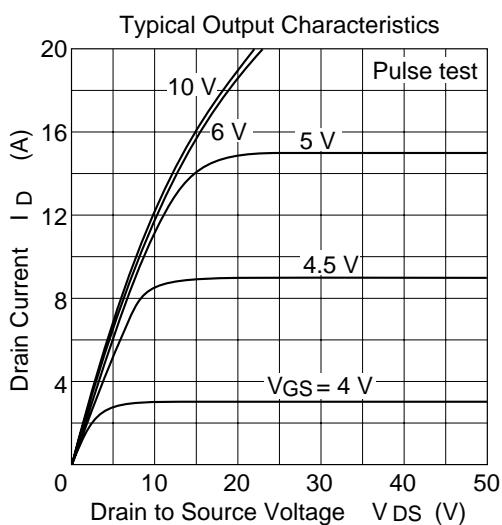
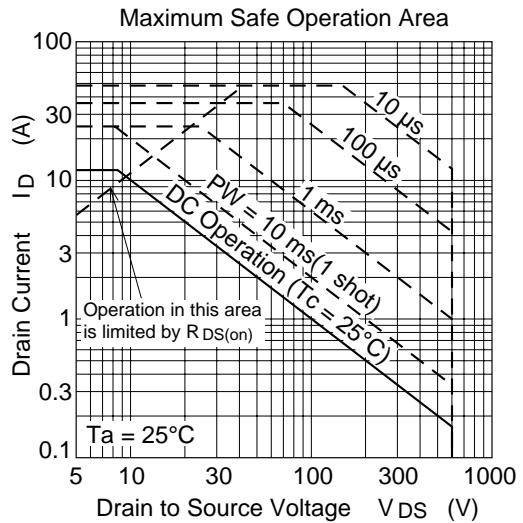
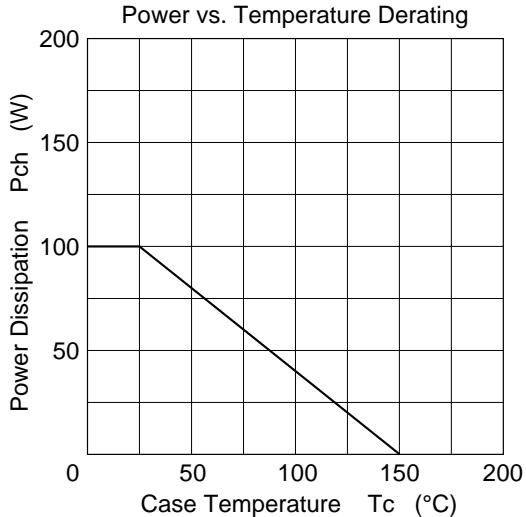
Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	600	V
Gate to source voltage	V <sub>GSS</sub>	±30	V
Drain current	I <sub>D</sub>	12	A
Drain peak current	I <sub>D(pulse)</sub> <sup>*1</sup>	48	A
Body to drain diode reverse drain current	I <sub>DR</sub>	12	A
Channel dissipation	Pch <sup>*2</sup>	100	W
Channel temperature	T <sub>ch</sub>	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

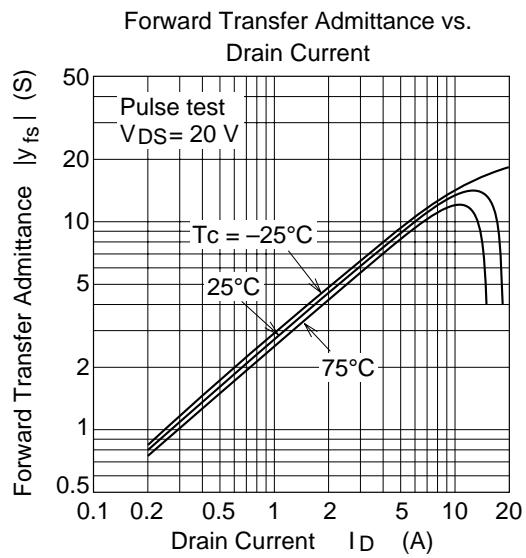
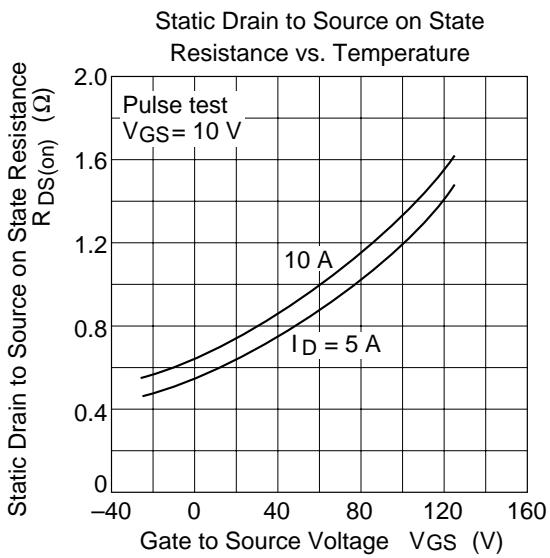
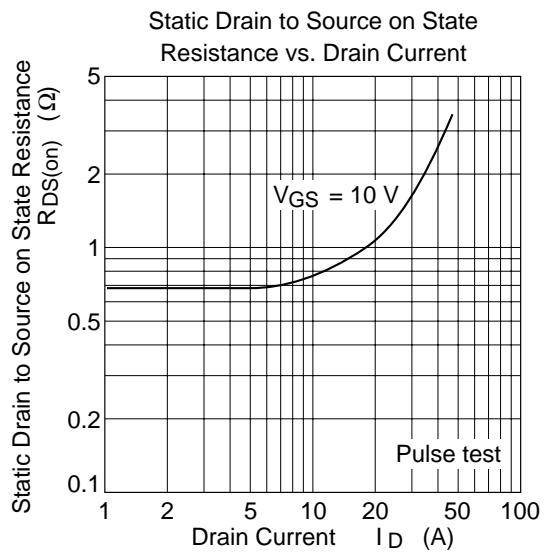
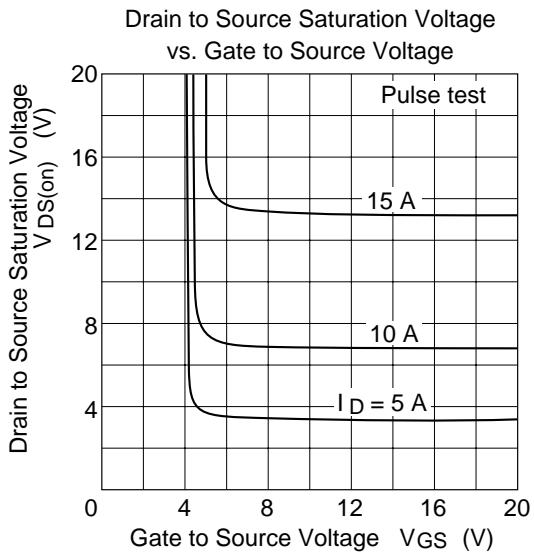
Notes 1. PW 10 µs, duty cycle 1 %  
2. Value at Tc = 25°C

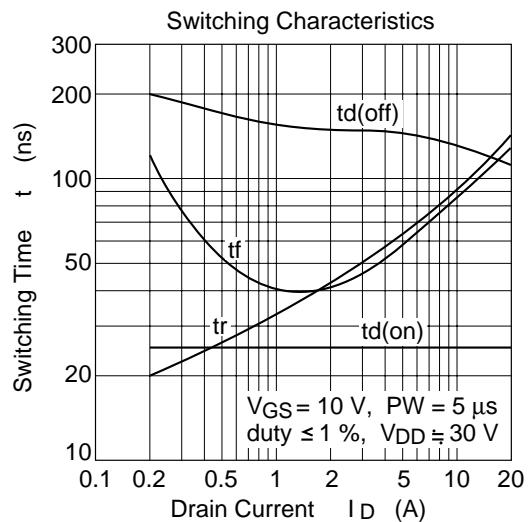
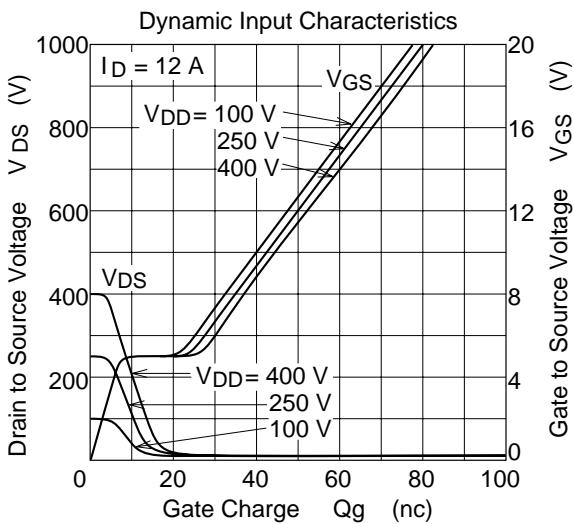
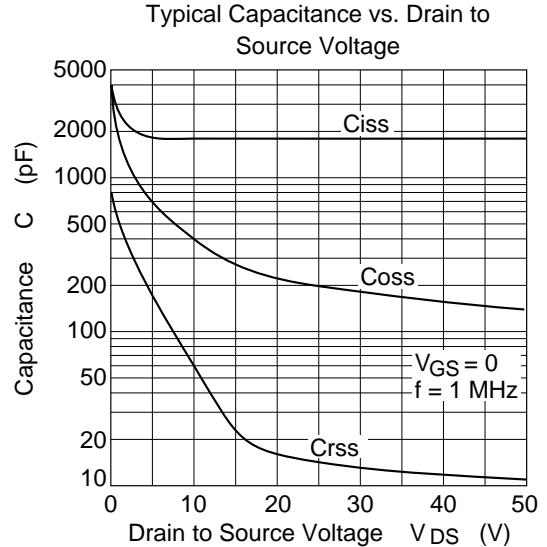
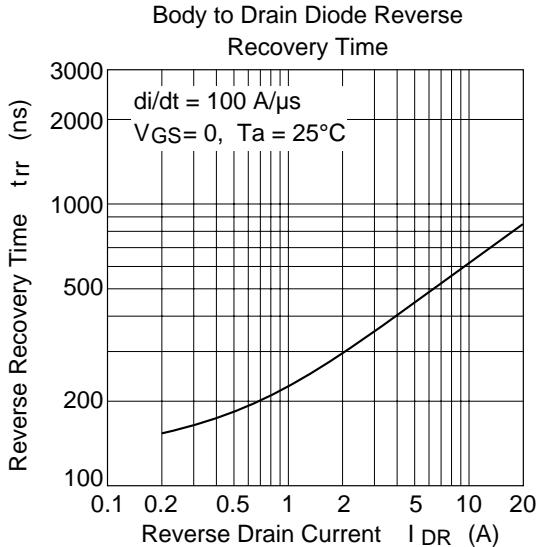
**Electrical Characteristics (Ta = 25°C)**

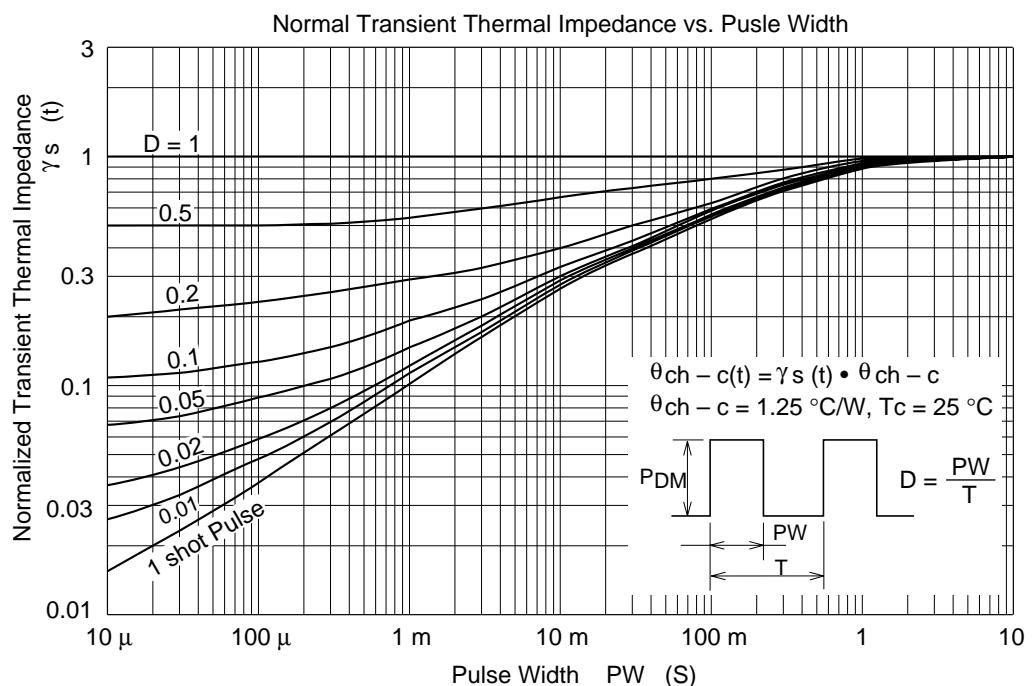
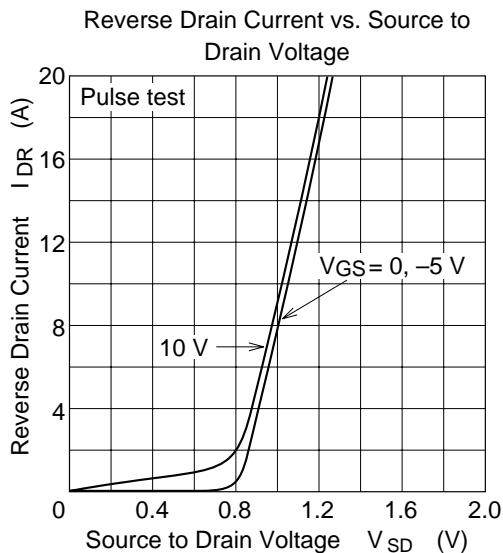
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	600	—	—	V	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0
Gate to source breakdown voltage	V <sub>(BR)GSS</sub>	±30	—	—	V	I <sub>G</sub> = ±100 µA, V <sub>DS</sub> = 0
Gate to source leak current	I <sub>GSS</sub>	—	—	±10	µA	V <sub>GS</sub> = ±25 V, V <sub>DS</sub> = 0
Zero gate voltage drain current	I <sub>DSS</sub>	—	—	250	µA	V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0
Gate to source cutoff voltage	V <sub>GS(off)</sub>	2.0	—	3.0	V	I <sub>D</sub> = 1 mA, V <sub>DS</sub> = 10 V
Static drain to source on state resistance	R <sub>DS(on)</sub>	—	0.68	0.88		I <sub>D</sub> = 6 A V <sub>GS</sub> = 10 V <sup>*1</sup>
Forward transfer admittance	y <sub>fs</sub>	5	10	—	S	I <sub>D</sub> = 6 A V <sub>DS</sub> = 10 V <sup>*1</sup>
Input capacitance	C <sub>iss</sub>	—	1800	—	pF	V <sub>DS</sub> = 10 V
Output capacitance	C <sub>oss</sub>	—	400	—	pF	V <sub>GS</sub> = 0
Reverse transfer capacitance	C <sub>rss</sub>	—	60	—	pF	f = 1 MHz
Turn-on delay time	t <sub>d(on)</sub>	—	25	—	ns	I <sub>D</sub> = 6 A
Rise time	t <sub>r</sub>	—	70	—	ns	V <sub>GS</sub> = 10 V
Turn-off delay time	t <sub>d(off)</sub>	—	145	—	ns	R <sub>L</sub> = 5
Fall time	t <sub>f</sub>	—	65	—	ns	
Body to drain diode forward voltage	V <sub>DF</sub>	—	1.1	—	V	I <sub>F</sub> = 12 A, V <sub>GS</sub> = 0
Body to drain diode reverse recovery time	t <sub>rr</sub>	—	670	—	ns	I <sub>F</sub> = 12 A, V <sub>GS</sub> = 0, di <sub>F</sub> / dt = 100 A / µs

Note 1. Pulse Test

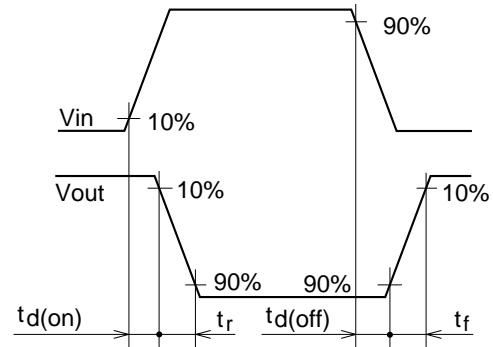
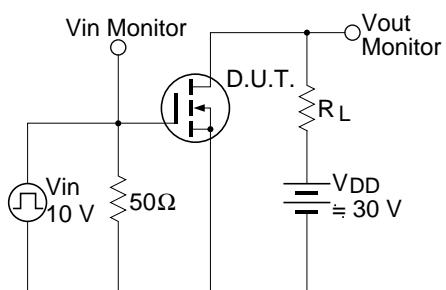








Switching Time Test Circuit and Waveform



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